

# APM2070P

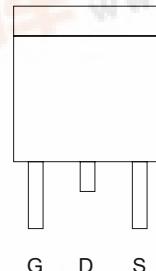


P-Channel Enhancement Mode MOSFET

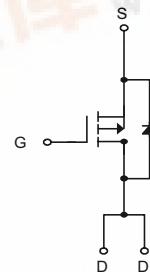
## Features

- 20V/-5A ,  $R_{DS(ON)} = 78m\Omega$ (typ.) @  $V_{GS} = -10V$   
 $R_{DS(ON)} = 113m\Omega$ (typ.) @  $V_{GS} = -4.5V$
- Super High Dense Cell Design for Extremely Low  $R_{DS(ON)}$
- Reliable and Rugged
- TO-252 Package

## Pin Description



Top View of TO-252



P-Channel MOSFET

## Applications

- Power Management in Notebook Computer , Portable Equipment and Battery Powered Systems.

## Ordering and Marking Information

APM2070P □□-□□ □	Package Code U : TO-252 Operating Junction Temp. Range C : -55 to 150 °C Handling Code TU : Tube      TR : Tape & Reel Lead Free Code L : Lead Free Device    Blank : Original Device
APM2070P U :  APM2070P XXXXX	XXXXX - Date Code

## Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
V <sub>DSS</sub>	Drain-Source Voltage	-20	V
V <sub>GSS</sub>	Gate-Source Voltage	±16	
I <sub>D</sub> <sup>*</sup>	Maximum Drain Current – Continuous	-5	A
I <sub>DM</sub>	Maximum Drain Current – Pulsed	-20	

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Absolute Maximum Ratings (Cont.) $(T_A = 25^\circ\text{C} \text{ unless otherwise noted})$

Symbol	Parameter		Rating	Unit
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	50	W
		$T_A=100^\circ\text{C}$	10	
$T_J$	Maximum Junction Temperature		150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55 to 150	$^\circ\text{C}$
$R_{\theta JA}^*$	Thermal Resistance – Junction to Ambient		50	$^\circ\text{C}/\text{W}$

\* Surface Mounted on FR4 Board,  $t \leq 10 \text{ sec.}$

## Electrical Characteristics $(T_A = 25^\circ\text{C} \text{ unless otherwise noted})$

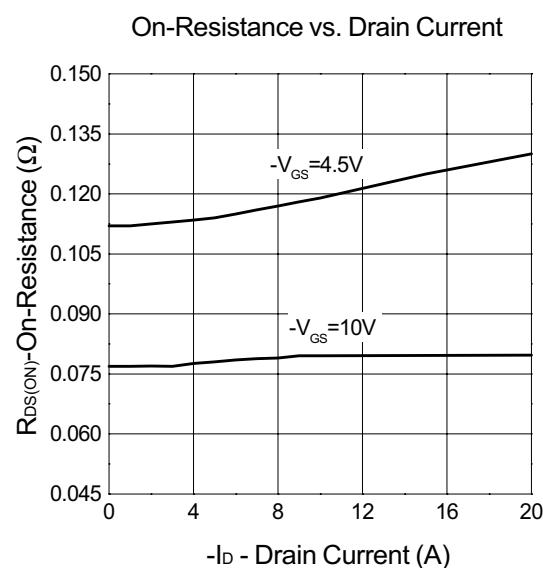
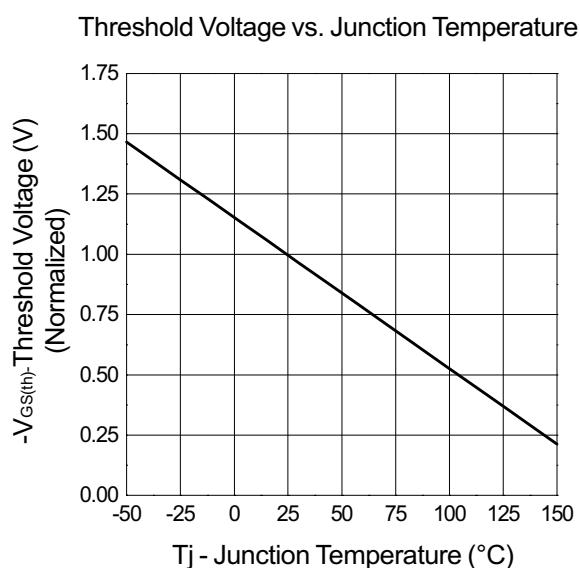
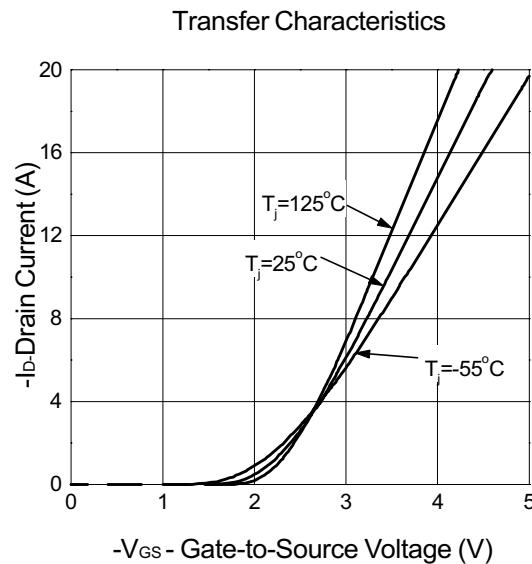
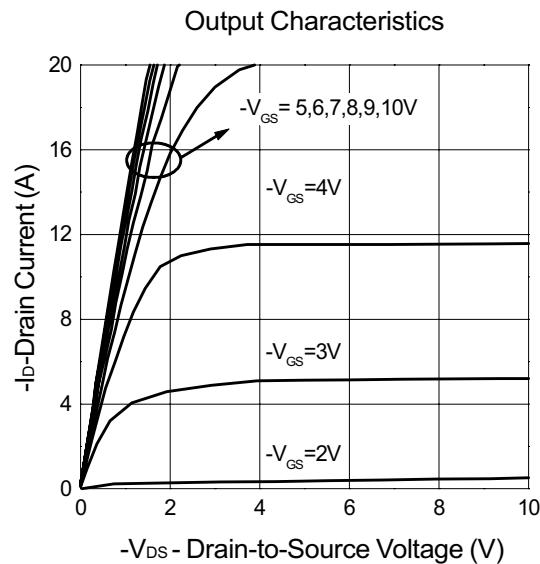
Symbol	Parameter	Test Condition	APM2070P			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_{DS}=-250\mu\text{A}$	-20			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-16\text{V}$ , $V_{GS}=0\text{V}$			-1	$\mu\text{A}$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{DS}=-250\mu\text{A}$	-0.7	-0.9	-1.5	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 16\text{V}$ , $V_{DS}=0\text{V}$			$\pm 100$	nA
$R_{DS(ON)}^a$	Drain-Source On-state Resistance	$V_{GS}=-10\text{V}$ , $I_{DS}=-5\text{A}$		78	102	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}$ , $I_{DS}=-2.8\text{A}$		113	150	
$V_{SD}^a$	Diode Forward Voltage	$I_S=-0.5\text{A}$ , $V_{GS}=0\text{V}$		-0.7	-1.3	V
<b>Dynamic<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=-10\text{V}$ , $I_{DS}=-5\text{A}$ $V_{GS}=-4.5\text{V}$		17	22	nC
$Q_{gs}$	Gate-Source Charge			4		
$Q_{gd}$	Gate-Drain Charge			5.2		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-10\text{V}$ , $I_{DS}=-5\text{A}$ , $V_{GEN}=-4.5\text{V}$ , $R_G=6\Omega$		13	25	ns
$T_r$	Turn-on Rise Time			36	67	
$t_{d(OFF)}$	Turn-off Delay Time			45	83	
$T_f$	Turn-off Fall Time			37	69	
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}$ $V_{DS}=-15\text{V}$ Frequency=1.0MHz		504		pF
$C_{oss}$	Output Capacitance			147		
$C_{rss}$	Reverse Transfer Capacitance			118		

### Notes

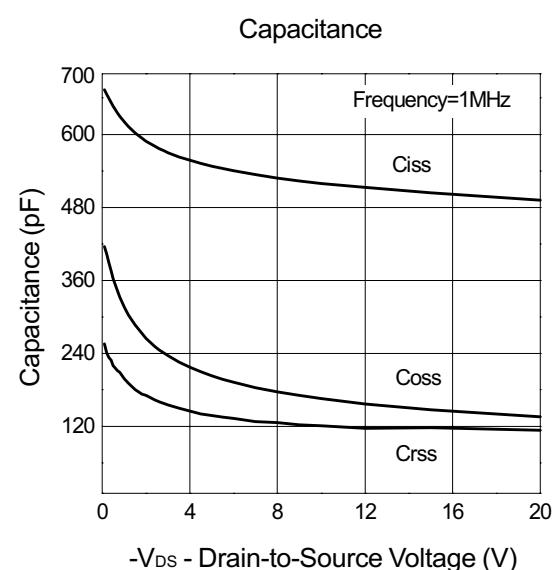
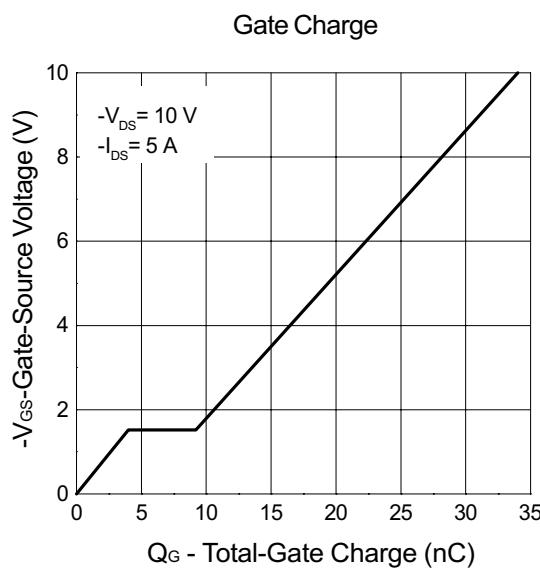
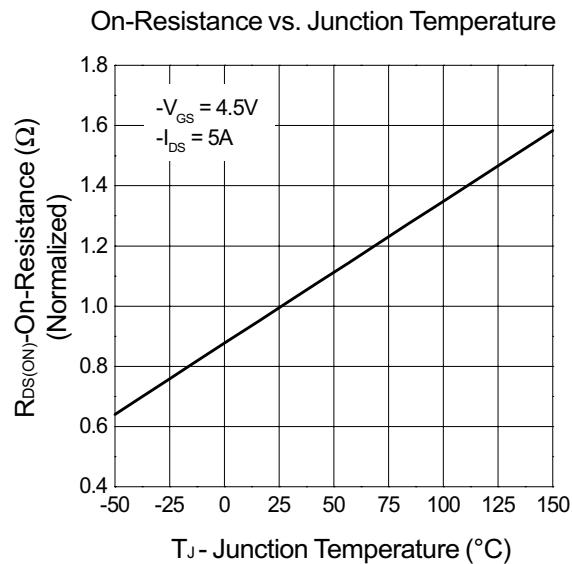
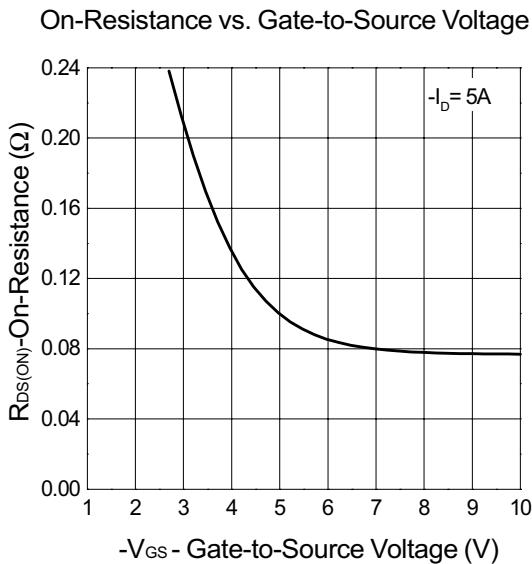
<sup>a</sup> : Pulse test ; pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$

<sup>b</sup> : Guaranteed by design, not subject to production testing

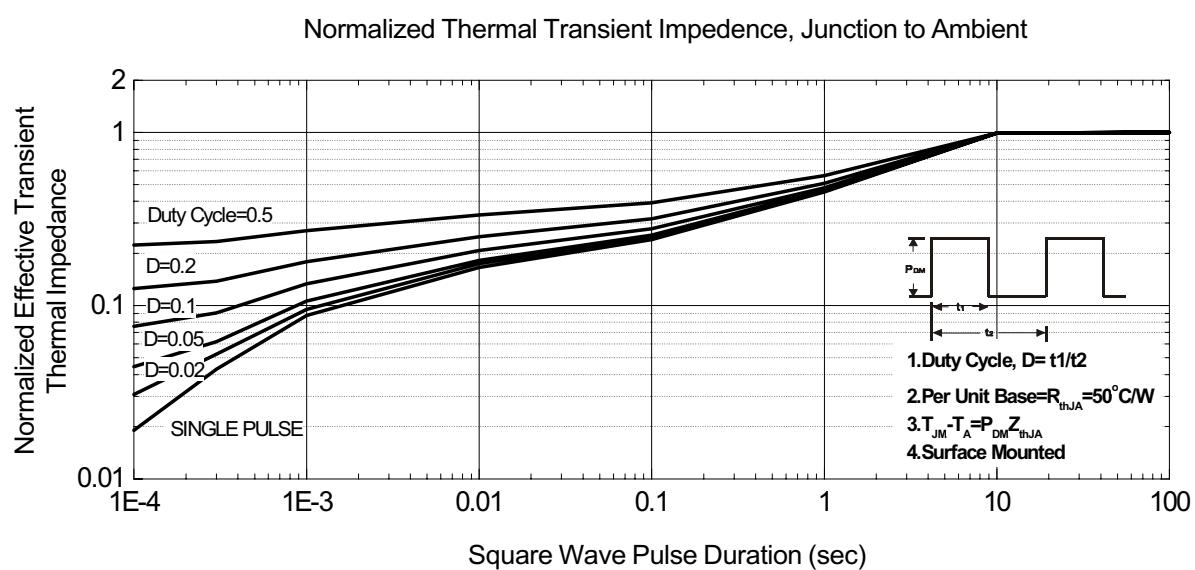
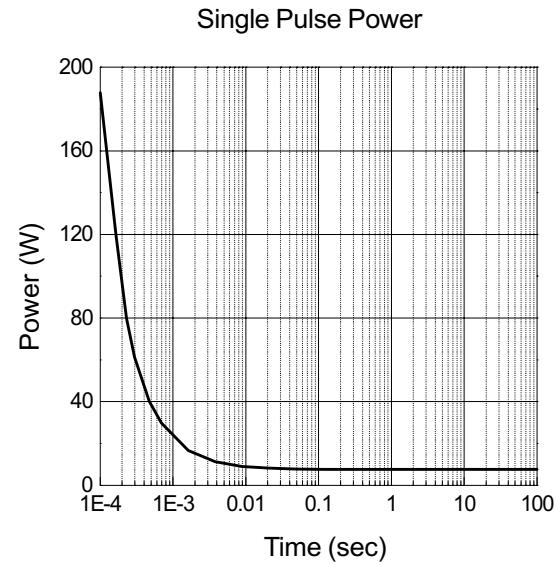
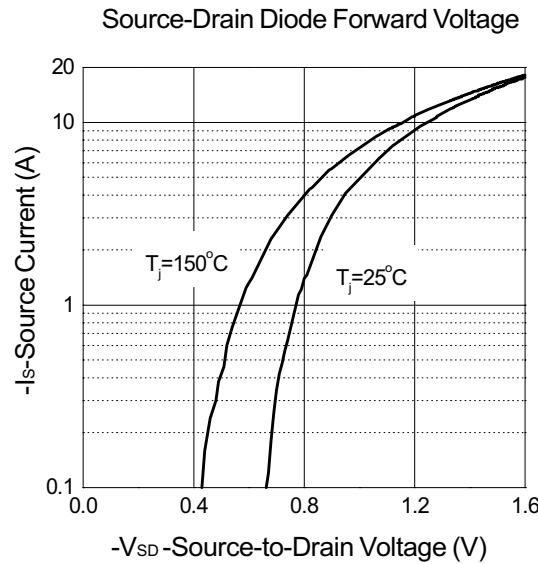
## Typical Characteristics



## Typical Characteristics (Cont.)

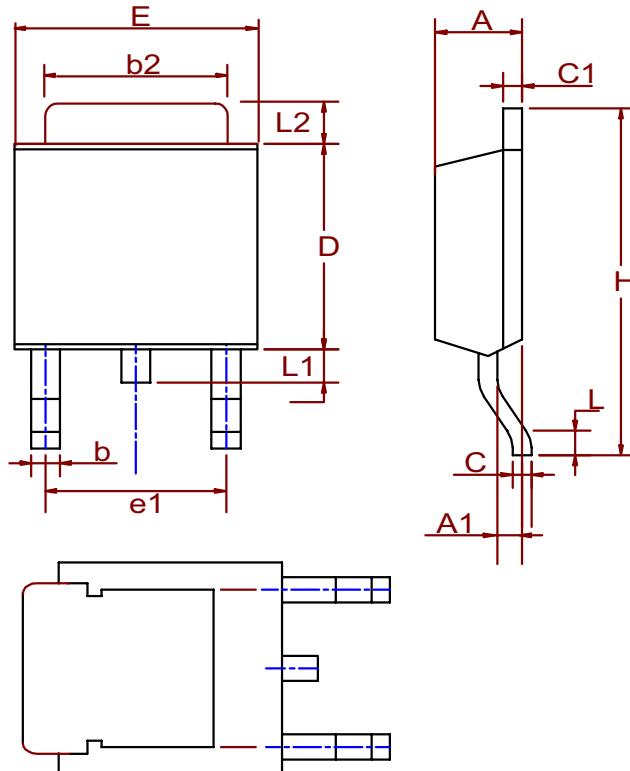


## Typical Characteristics (Cont.)



## Packaging Information

TO-252( Reference JEDEC Registration TO-252)



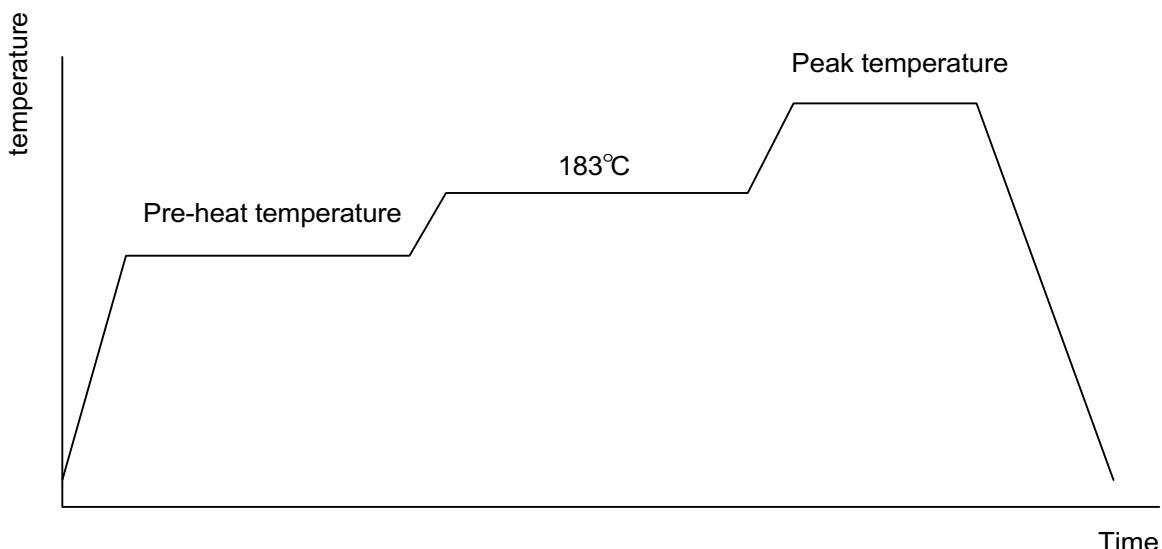
Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.18	2.39	0.086	0.094
A1	0.89	1.27	0.035	0.050
b	0.508	0.89	0.020	0.035
b2	5.207	5.461	0.205	0.215
C	0.46	0.58	0.018	0.023
C1	0.46	0.58	0.018	0.023
D	5.334	6.22	0.210	0.245
E	6.35	6.73	0.250	0.265
e1	3.96	5.18	0.156	0.204
H	9.398	10.41	0.370	0.410
L	0.51		0.020	
L1	0.64	1.02	0.025	0.040
L2	0.89	2.032	0.035	0.080

## Physical Specifications

Terminal Material	Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb)
Lead Solderability	Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3.

### Reflow Condition (IR/Convection or VPR Reflow)

Reference JEDEC Standard J-STD-020A APRIL 1999



### Classification Reflow Profiles

	Convection or IR/ Convection	VPR
Average ramp-up rate(183°C to Peak)	3°C/second max.	10 °C /second max.
Preheat temperature 125 ± 25°C)	120 seconds max.	
Temperature maintained above 183°C	60 ~ 150 seconds	
Time within 5°C of actual peak temperature	10 ~ 20 seconds	60 seconds
Peak temperature range	220 +5/-0°C or 235 +5/-0°C	215~ 219°C or 235 +5/-0°C
Ramp-down rate	6 °C /second max.	10 °C /second max.
Time 25°C to peak temperature	6 minutes max.	

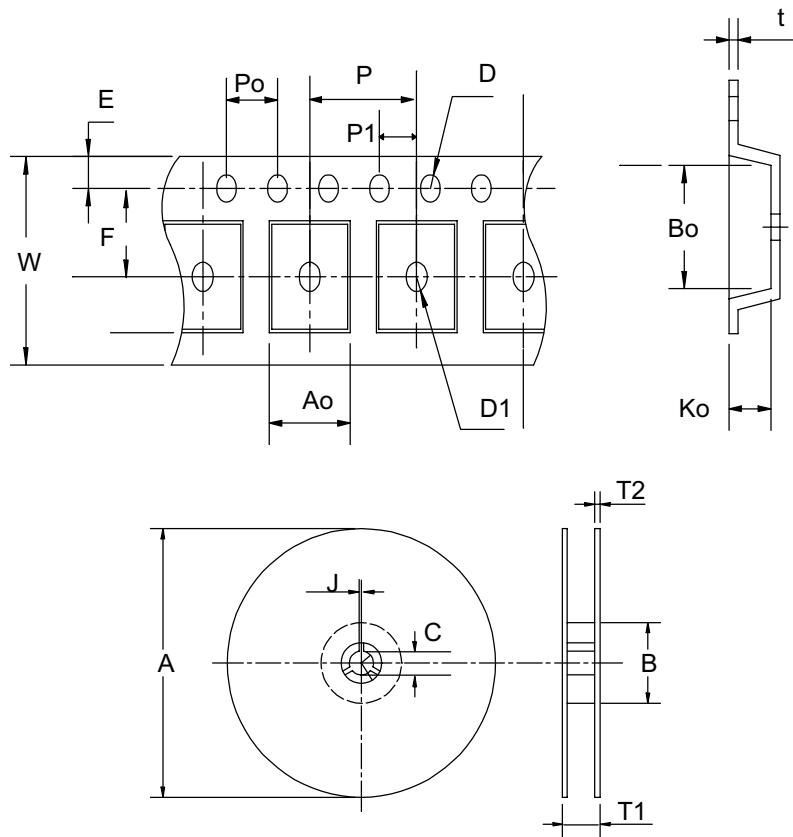
### Package Reflow Conditions

pkg. thickness ≥ 2.5mm and all bags	pkg. thickness < 2.5mm and pkg. volume ≥ 350 mm <sup>3</sup>	pkg. thickness < 2.5mm and pkg. volume < 350mm <sup>3</sup>
Convection 220 +5/-0 °C		Convection 235 +5/-0 °C
VPR 215-219 °C		VPR 235 +5/-0 °C
IR/Convection 220 +5/-0 °C		IR/Convection 235 +5/-0 °C

## Reliability test program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 SEC
HOLT	MIL-STD 883D-1005.7	1000 Hrs Bias @ 125°C
PCT	JESD-22-B, A102	168 Hrs, 100% RH, 121°C
TST	MIL-STD 883D-1011.9	-65°C ~ 150°C, 200 Cycles

## Carrier Tape & Reel Dimensions



Application	A	B	C	J	T1	T2	W	P	E
TO-252	$330 \pm 3$	$100 \pm 2$	$13 \pm 0.5$	$2 \pm 0.5$	$16.4 \pm 0.3$ -0.2	$2.5 \pm 0.5$	$16 \pm 0.3$ -0.1	$8 \pm 0.1$	$1.75 \pm 0.1$
	F	D	D1	Po	P1	Ao	Bo	Ko	t
	$7.5 \pm 0.1$	$1.5 \pm 0.1$	$1.5 \pm 0.25$	$4.0 \pm 0.1$	$2.0 \pm 0.1$	$6.8 \pm 0.1$	$10.4 \pm 0.1$	$2.5 \pm 0.1$	$0.3 \pm 0.05$

## Cover Tape Dimensions

Application	Carrier Width	Cover Tape Width	Devices Per Reel
TO- 252	16	13.3	2500

## Customer Service

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